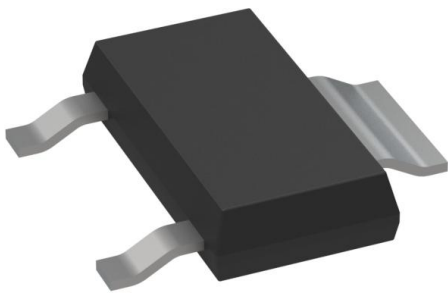


IPN70R1K5CEATMA1 Datasheet

www.digi-electronics.com



<https://www.DiGi-Electronics.com>

| | |
|------------------------------|--|
| DiGi Electronics Part Number | IPN70R1K5CEATMA1-DG |
| Manufacturer | Infineon Technologies |
| Manufacturer Product Number | IPN70R1K5CEATMA1 |
| Description | MOSFET N-CH 700V 5.4A SOT223 |
| Detailed Description | N-Channel 700 V 5.4A (Tc) 5W (Tc) Surface Mount P G-SOT223-3 |



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

IPN70R1K5CEATMA1

Series:

CoolMOS™

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

700 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

3.5V @ 100µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-40°C ~ 150°C (Tj)

Supplier Device Package:

PG-SOT223-3

Base Product Number:

IPN70R1

Manufacturer:

Infineon Technologies

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

5.4A (Tc)

Rds On (Max) @ Id, Vgs:

1.50hm @ 1A, 10V

Gate Charge (Qg) (Max) @ Vgs:

10.5 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

225 pF @ 100 V

Power Dissipation (Max):

5W (Tc)

Mounting Type:

Surface Mount

Package / Case:

TO-261-4, TO-261AA

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

MOSFET

700V CoolMOS™ CE Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ CE is a price-performance optimized platform enabling to target cost sensitive applications in Consumer and Lighting markets by still meeting highest efficiency standards. The new series provides all benefits of a fast switching Superjunction MOSFET while not sacrificing ease of use and offering the best cost down performance ratio available on the market.

Features

- Extremely low losses due to very low FOM $R_{DS(on)} \cdot Q_g$ and E_{oss}
- Very high commutation ruggedness
- Easy to use/drive
- Pb-free plating, Halogen free mold compound
- Qualified for standard grade applications

Applications

Adapter, Charger and Lighting

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

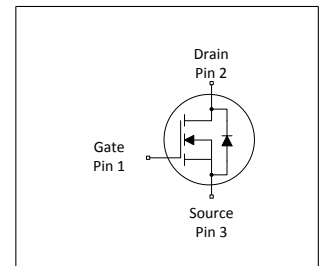
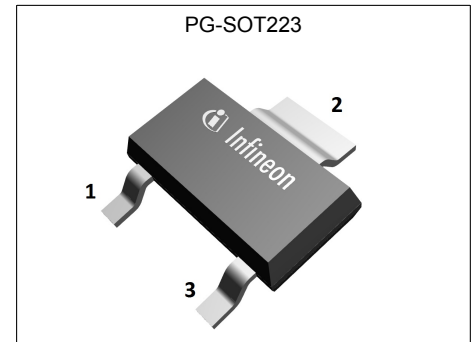


Table 1 Key Performance Parameters

| Parameter | Value | Unit |
|----------------------|-------|------------|
| $V_{DS} @ T_{j,max}$ | 750 | V |
| $R_{DS(on),max}$ | 1.5 | Ω |
| $Q_{g,typ}$ | 10.5 | nC |
| $I_{D,pulse}$ | 8.8 | A |
| $E_{oss}@400V$ | 1.2 | μJ |
| Body diode di/dt | 500 | A/ μs |

| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|-----------|---------|----------------|
| IPN70R1K5CE | PG-SOT223 | 70S1K5 | see Appendix A |



700V CoolMOS™ CE Power Transistor

IPN70R1K5CE

Table of Contents

| | |
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700V CoolMOS™ CE Power Transistor

IPN70R1K5CE

1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

Table 2 Maximum ratings

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|---|----------------|------------|------|------------|------------------|---|
| | | Min. | Typ. | Max. | | |
| Continuous drain current ¹⁾ | I_D | - | - | 5.4 3.4 | A | $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$ |
| Pulsed drain current ²⁾ | $I_{D,pulse}$ | - | - | 8.8 | A | $T_C = 25^\circ\text{C}$ |
| Avalanche energy, single pulse | E_{AS} | - | - | 26 | mJ | $I_D = 0.6\text{A}$; $V_{DD} = 50\text{V}$ |
| Avalanche energy, repetitive | E_{AR} | - | - | 0.10 | mJ | $I_D = 0.6\text{A}$; $V_{DD} = 50\text{V}$ |
| Avalanche current, repetitive | I_{AR} | - | - | 0.6 | A | - |
| MOSFET dv/dt ruggedness | dv/dt | - | - | 50 | V/ns | $V_{DS} = 0 \dots 480\text{V}$ |
| Gate source voltage | V_{GS} | -20 -30 | - | 20 30 | V | static; AC ($f > 1\text{ Hz}$) |
| Power dissipation | P_{tot} | - | - | 5.0 | W | $T_C = 25^\circ\text{C}$ |
| Operating and storage temperature | T_j, T_{stg} | -40 | - | 150 | $^\circ\text{C}$ | - |
| Continuous diode forward current | I_S | - | - | 1.2 | A | $T_C = 25^\circ\text{C}$ |
| Diode pulse current ²⁾ | $I_{S,pulse}$ | - | - | 8.8 | A | $T_C = 25^\circ\text{C}$ |
| Reverse diode dv/dt ³⁾ | dv/dt | - | - | 15 | V/ns | $V_{DS} = 0 \dots 400\text{V}$, $I_{SD} \leq I_S$, $T_j = 25^\circ\text{C}$ |
| Maximum diode commutation speed ³⁾ | di/dt | - | - | 500 | A/ μs | $V_{DS} = 0 \dots 400\text{V}$, $I_{SD} \leq I_S$, $T_j = 25^\circ\text{C}$ |

2 Thermal characteristics

Table 3 Thermal characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|--|------------|--------|------|------|--------------------|---|
| | | Min. | Typ. | Max. | | |
| Thermal resistance, junction - solder point | R_{thJS} | - | - | 23.8 | $^\circ\text{C/W}$ | - |
| Thermal resistance, junction - ambient for minimal footprint | R_{thJA} | - | - | 160 | $^\circ\text{C/W}$ | minimal footprint |
| Thermal resistance, junction - ambient soldered on copper area | R_{thJA} | - | - | 75 | $^\circ\text{C/W}$ | Device on 40mm*40mm*1.5 epoxy PCB FR4 with 6cm ² (one layer 70 μm thick) copper area for drain connection and cooling. PCB is vertical without blown air. |
| Soldering temperature, wavesoldering only allowed at leads | T_{sold} | - | - | 260 | $^\circ\text{C}$ | reflow MSL3 |

¹⁾ DPAK equivalent. Limited by $T_{j,max}$. Maximum duty cycle $D=0.5$

²⁾ Pulse width t_p limited by $T_{j,max}$

³⁾ $V_{DClink}=400\text{V}$; $V_{DS,peak} < V_{(BR)DSS}$; identical low side and high side switch with identical R_G

700V CoolMOS™ CE Power Transistor IPN70R1K5CE

3 Electrical characteristics

Table 4 Static characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|----------------------------------|---------------|--------|------|------|----------|---|
| | | Min. | Typ. | Max. | | |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | 700 | - | - | V | $V_{GS}=0V, I_D=1mA$ |
| Gate threshold voltage | $V_{GS(th)}$ | 2.50 | 3 | 3.50 | V | $V_{DS}=V_{GS}, I_D=0.1mA$ |
| Zero gate voltage drain current | I_{DSS} | - | - | 1 | μA | $V_{DS}=700V, V_{GS}=0V, T_j=25^\circ C$ $V_{DS}=700V, V_{GS}=0V, T_j=150^\circ C$ |
| Gate-source leakage current | I_{GSS} | - | - | 100 | nA | $V_{GS}=20V, V_{DS}=0V$ |
| Drain-source on-state resistance | $R_{DS(on)}$ | - | 1.35 | 1.50 | Ω | $V_{GS}=10V, I_D=1A, T_j=25^\circ C$ $V_{GS}=10V, I_D=1A, T_j=150^\circ C$ |
| Gate resistance | R_G | - | 6.5 | - | Ω | $f=1\text{ MHz, open drain}$ |

Table 5 Dynamic characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|--|--------------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Input capacitance | C_{iss} | - | 225 | - | pF | $V_{GS}=0V, V_{DS}=100V, f=1MHz$ |
| Output capacitance | C_{oss} | - | 18 | - | pF | $V_{GS}=0V, V_{DS}=100V, f=1MHz$ |
| Effective output capacitance, energy related ¹⁾ | $C_{o(er)}$ | - | 10 | - | pF | $V_{GS}=0V, V_{DS}=0...480V$ |
| Effective output capacitance, time related ²⁾ | $C_{o(tr)}$ | - | 42 | - | pF | $I_D=constant, V_{GS}=0V, V_{DS}=0...480V$ |
| Turn-on delay time | $t_{d(on)}$ | - | 7.7 | - | ns | $V_{DD}=400V, V_{GS}=13V, I_D=1.5A,$ $R_G=10.2\Omega$ |
| Rise time | t_r | - | 5.9 | - | ns | $V_{DD}=400V, V_{GS}=13V, I_D=1.5A,$ $R_G=10.2\Omega$ |
| Turn-off delay time | $t_{d(off)}$ | - | 33 | - | ns | $V_{DD}=400V, V_{GS}=13V, I_D=1.5A,$ $R_G=10.2\Omega$ |
| Fall time | t_f | - | 18.2 | - | ns | $V_{DD}=400V, V_{GS}=13V, I_D=1.5A,$ $R_G=10.2\Omega$ |

Table 6 Gate charge characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|-----------------------|---------------|--------|------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Gate to source charge | Q_{gs} | - | 1.3 | - | nC | $V_{DD}=480V, I_D=1.5A, V_{GS}=0\text{ to }10V$ |
| Gate to drain charge | Q_{gd} | - | 5.8 | - | nC | $V_{DD}=480V, I_D=1.5A, V_{GS}=0\text{ to }10V$ |
| Gate charge total | Q_g | - | 10.5 | - | nC | $V_{DD}=480V, I_D=1.5A, V_{GS}=0\text{ to }10V$ |
| Gate plateau voltage | $V_{plateau}$ | - | 5.4 | - | V | $V_{DD}=480V, I_D=1.5A, V_{GS}=0\text{ to }10V$ |

¹⁾ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 480V

²⁾ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 480V



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IPN70R1K5CE

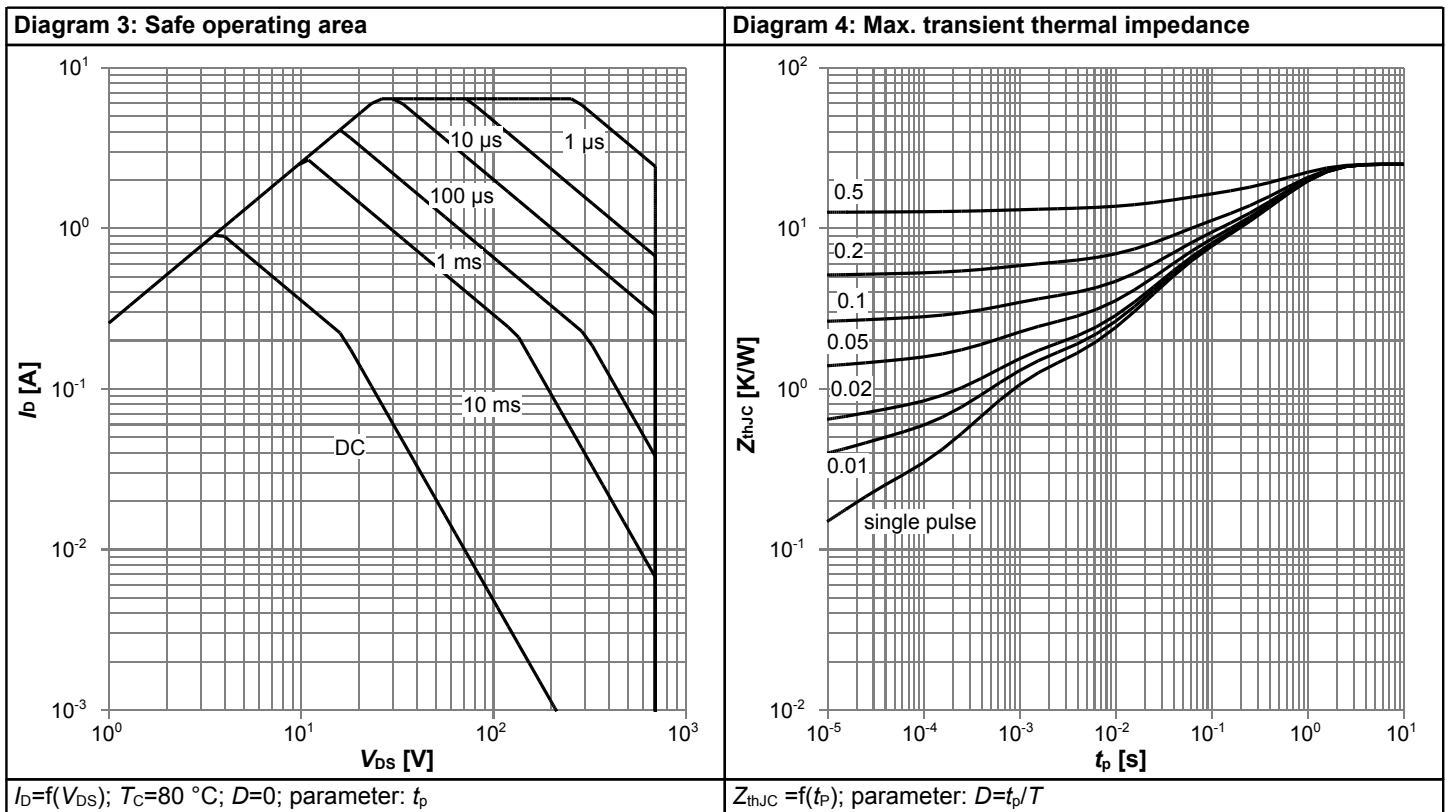
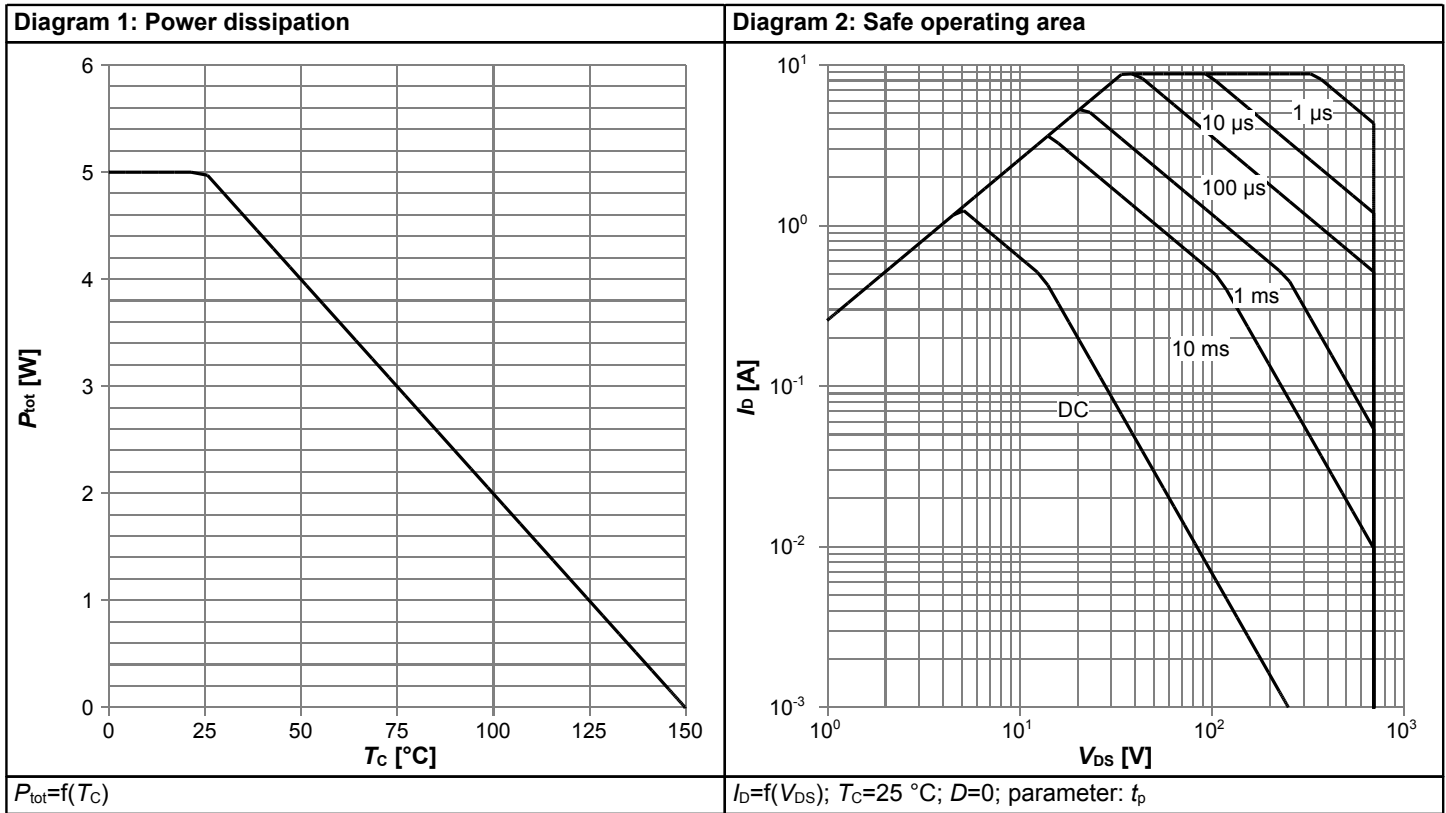
Table 7 Reverse diode characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|-------------------------------|-----------|--------|------|------|---------|--|
| | | Min. | Typ. | Max. | | |
| Diode forward voltage | V_{SD} | - | 0.9 | - | V | $V_{GS}=0V, I_F=1.5A, T_i=25^\circ C$ |
| Reverse recovery time | t_{rr} | - | 200 | - | ns | $V_R=400V, I_F=1.5A, di_F/dt=100A/\mu s$ |
| Reverse recovery charge | Q_{rr} | - | 0.9 | - | μC | $V_R=400V, I_F=1.5A, di_F/dt=100A/\mu s$ |
| Peak reverse recovery current | I_{rrm} | - | 8 | - | A | $V_R=400V, I_F=1.5A, di_F/dt=100A/\mu s$ |



700V CoolMOS™ CE Power Transistor
IPN70R1K5CE

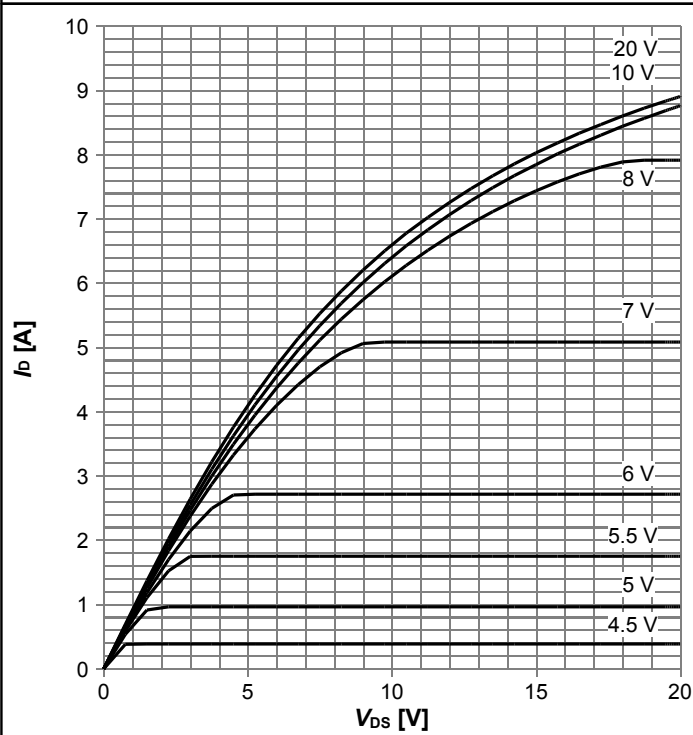
4 Electrical characteristics diagrams





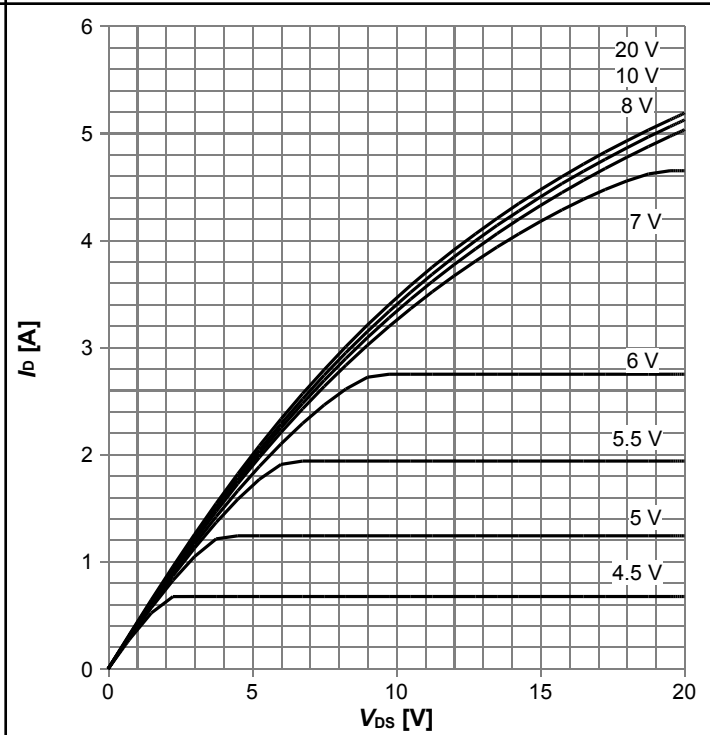
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IPN70R1K5CE

Diagram 5: Typ. output characteristics



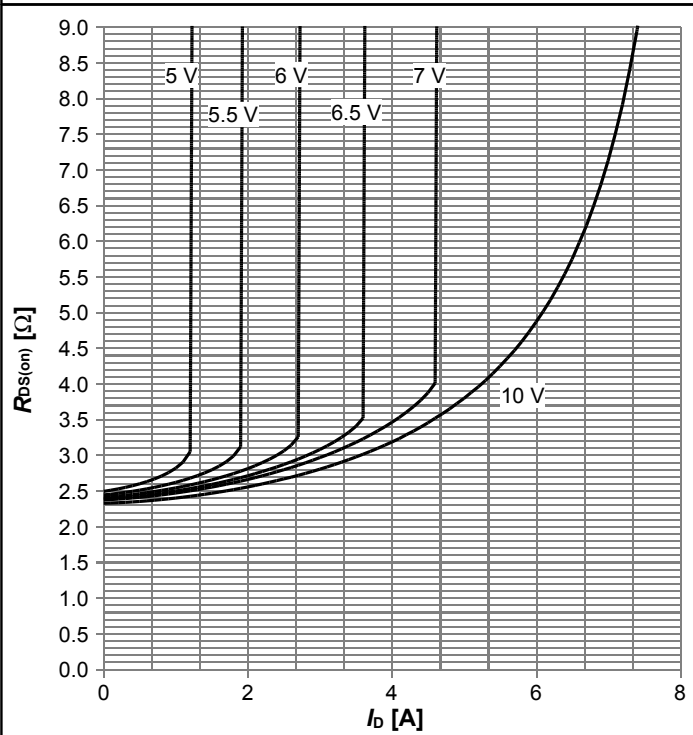
$I_D=f(V_{DS})$; $T_j=25^\circ\text{C}$; parameter: V_{GS}

Diagram 6: Typ. output characteristics



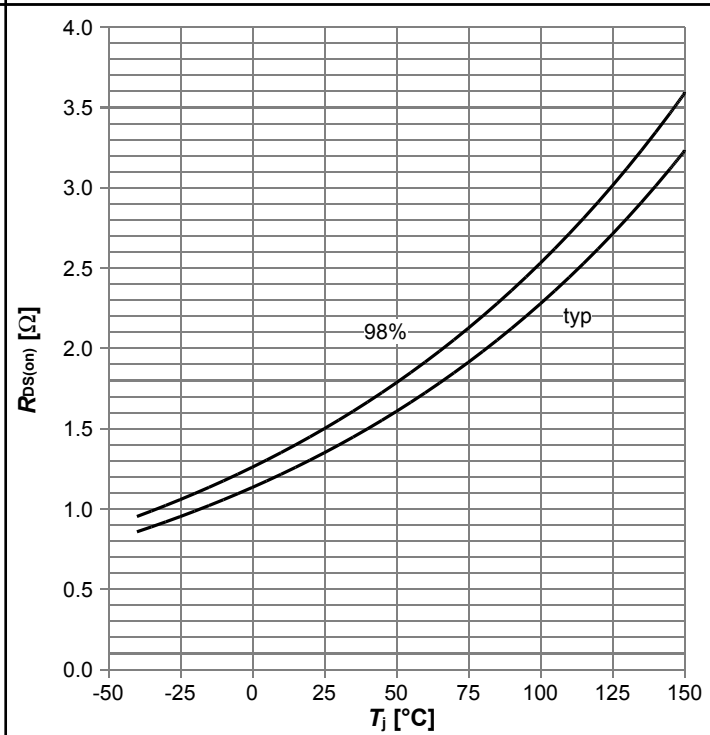
$I_D=f(V_{DS})$; $T_j=125^\circ\text{C}$; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



$R_{DS(on)}=f(I_D)$; $T_j=125^\circ\text{C}$; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance

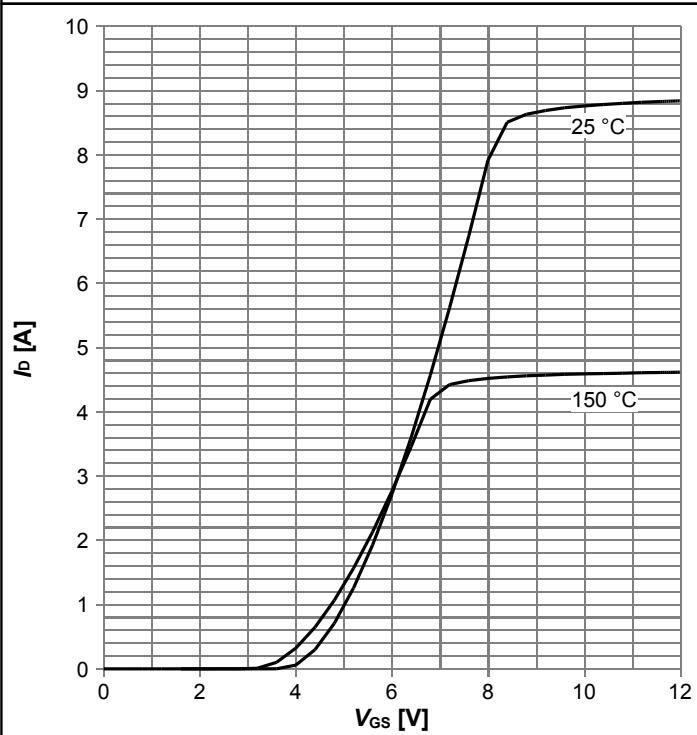


$R_{DS(on)}=f(T_j)$; $I_D=1.0\text{ A}$; $V_{GS}=10\text{ V}$



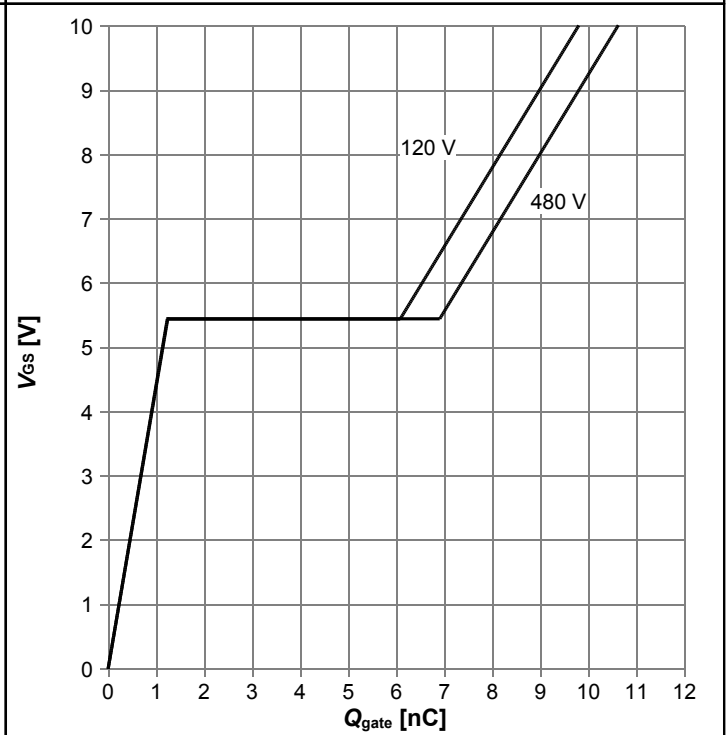
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Diagram 9: Typ. transfer characteristics



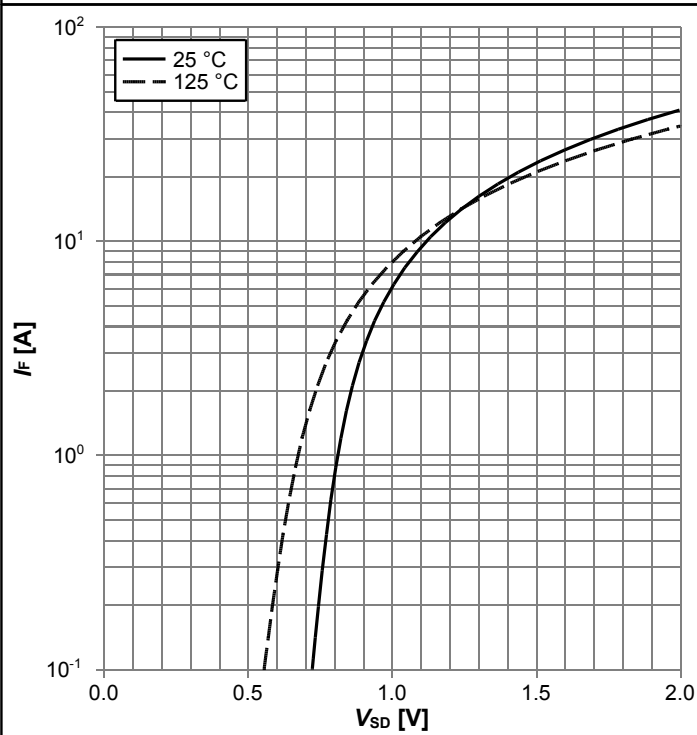
$I_D=f(V_{GS}); V_{DS}=20V; \text{parameter: } T_j$

Diagram 10: Typ. gate charge



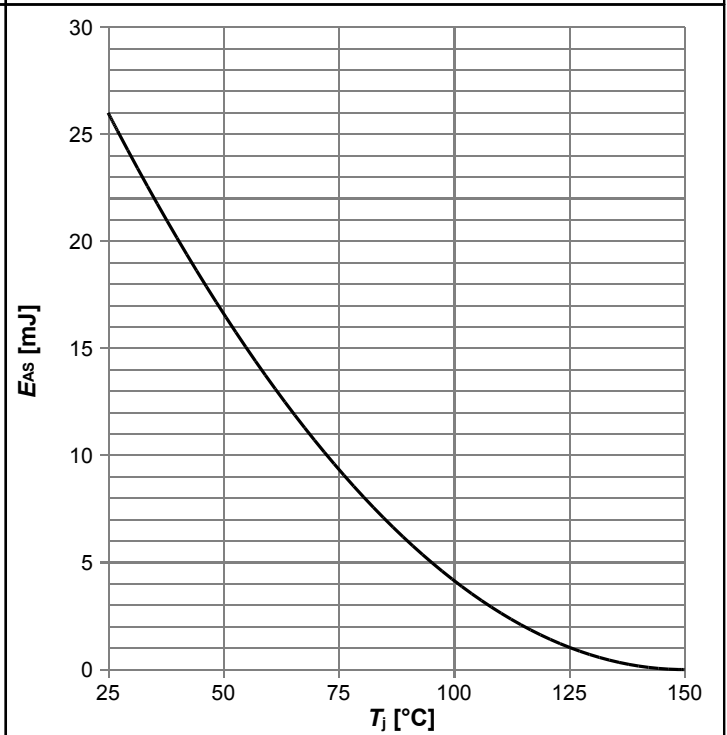
$V_{GS}=f(Q_{gate}); I_D=1.5 \text{ A pulsed}; \text{parameter: } V_{DD}$

Diagram 11: Forward characteristics of reverse diode



$I_F=f(V_{SD}); \text{parameter: } T_j$

Diagram 12: Avalanche energy

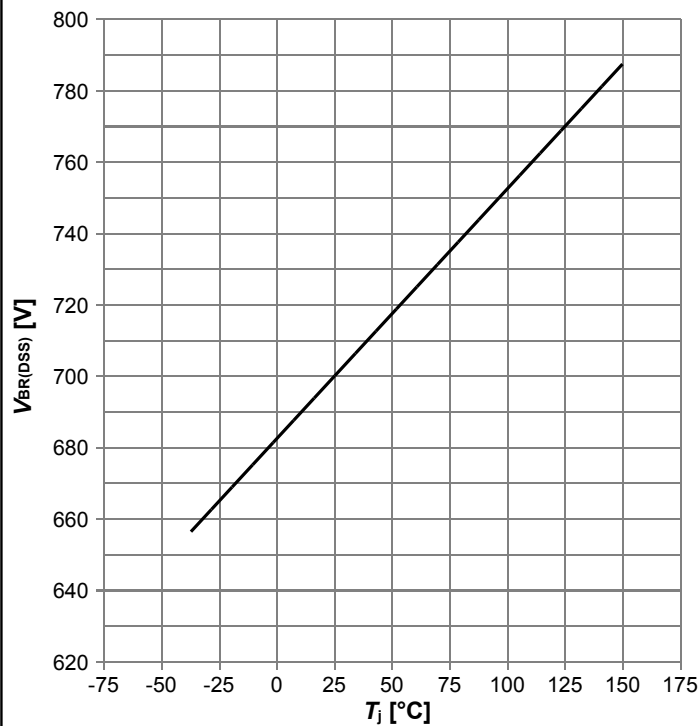


$E_{AS}=f(T_j); I_D=0.6 \text{ A}; V_{DD}=50 \text{ V}$



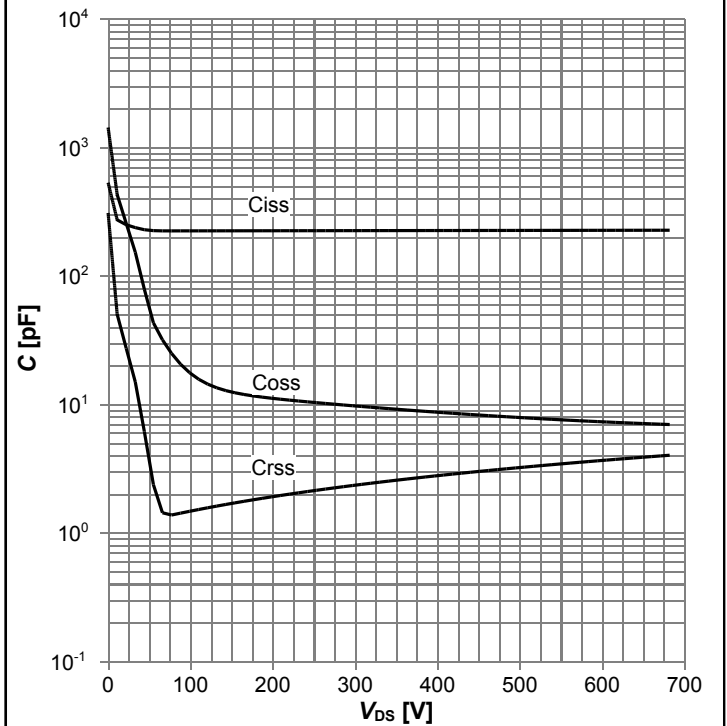
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Diagram 13: Drain-source breakdown voltage



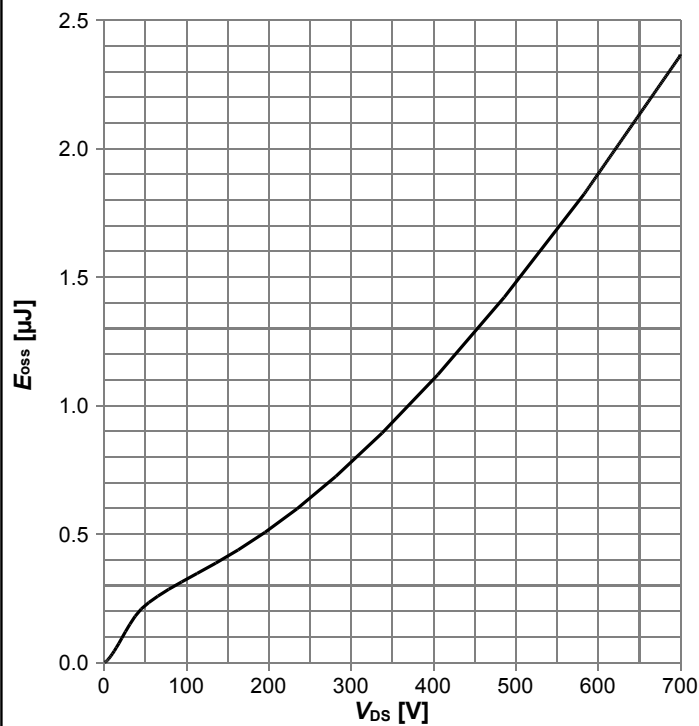
$V_{BR(DSS)}=f(T_j); I_D=1 \text{ mA}$

Diagram 14: Typ. capacitances



$C=f(V_{DS}); V_{GS}=0 \text{ V}; f=1 \text{ MHz}$

Diagram 15: Typ. Coss stored energy



$E_{oss}=f(V_{DS})$

700V CoolMOS™ CE Power Transistor
IPN70R1K5CE

5 Test Circuits

Table 8 Diode characteristics

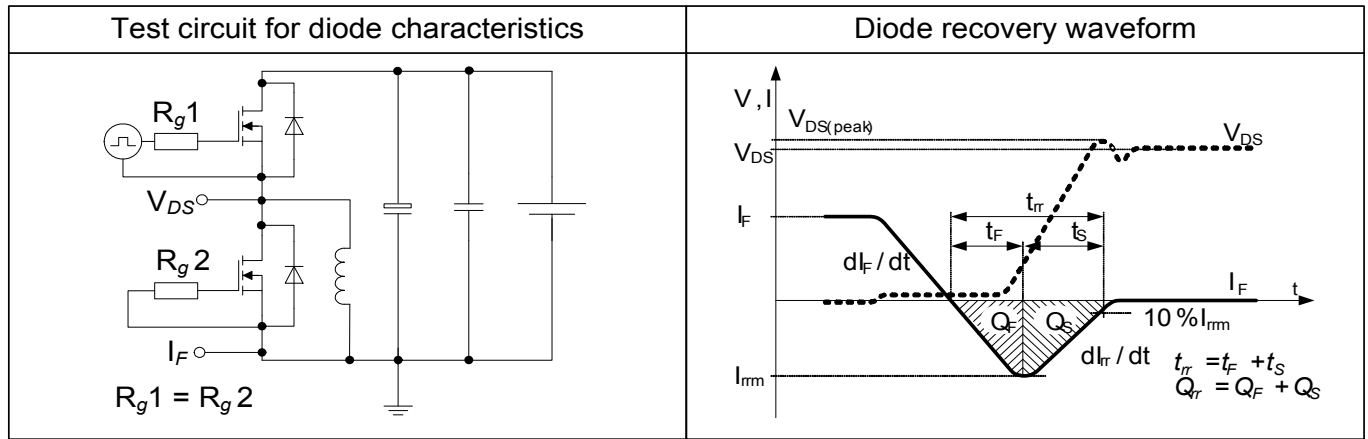


Table 9 Switching times

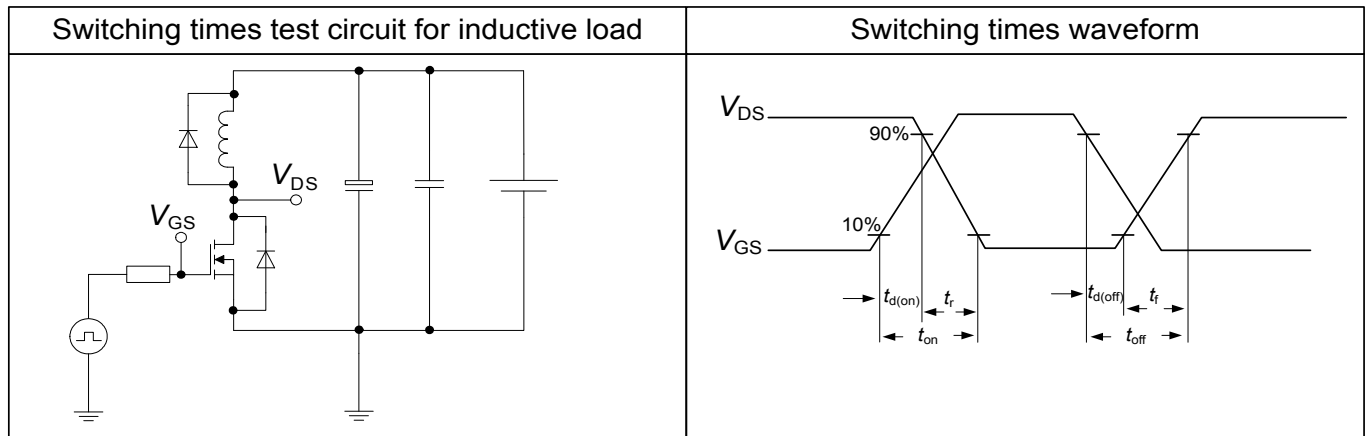
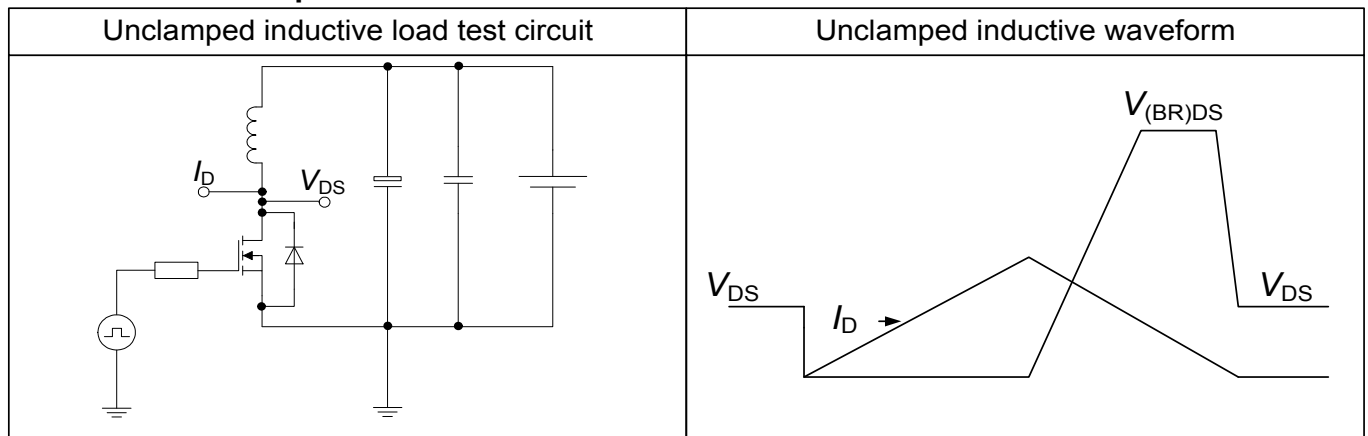
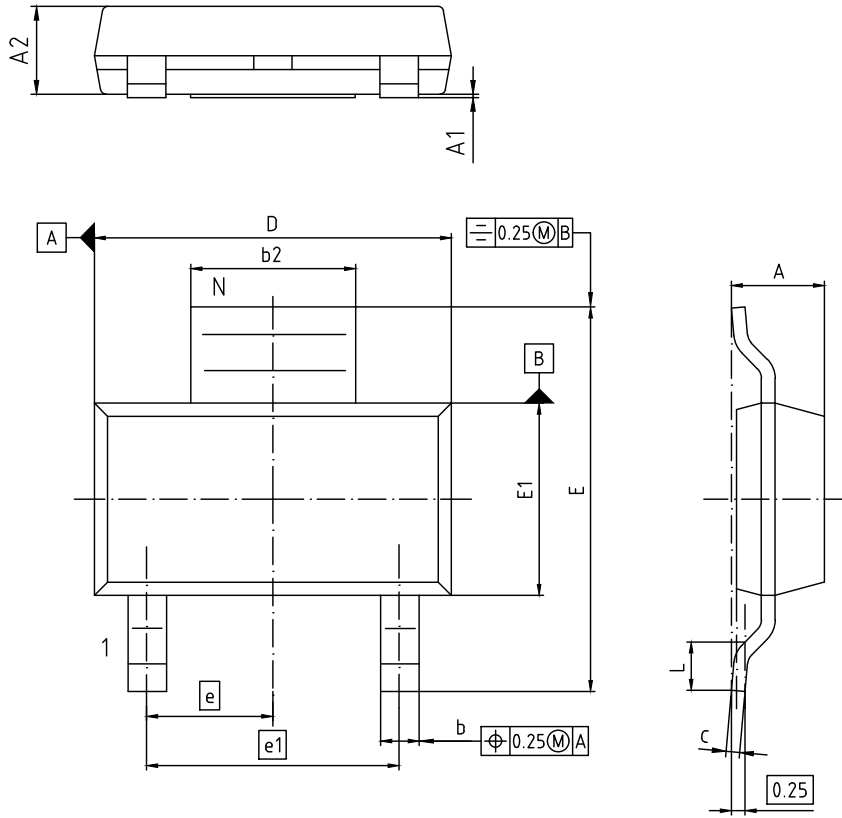


Table 10 Unclamped inductive load



700V CoolMOS™ CE Power Transistor
IPN70R1K5CE

6 Package Outlines



NOTES:
 1. ALL DIMENSIONS REFER TO JEDEC STANDARD TO-261

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.52 | 1.80 | 0.060 | 0.071 |
| A1 | - | 0.10 | - | 0.004 |
| A2 | 1.50 | 1.70 | 0.059 | 0.067 |
| b | 0.60 | 0.80 | 0.024 | 0.031 |
| b2 | 2.95 | 3.10 | 0.116 | 0.122 |
| c | 0.24 | 0.32 | 0.009 | 0.013 |
| D | 6.30 | 6.70 | 0.248 | 0.264 |
| E | 6.70 | 7.30 | 0.264 | 0.287 |
| E1 | 3.30 | 3.70 | 0.130 | 0.146 |
| e | 2.3 BASIC | | 0.091 BASIC | |
| e1 | 4.6 BASIC | | 0.181 BASIC | |
| L | 0.75 | 1.10 | 0.030 | 0.043 |
| N | 3 | | 3 | |
| O | 0° | 10° | 0° | 10° |

DOCUMENT NO.
Z8B00180553

SCALE

EUROPEAN PROJECTION

ISSUE DATE
24-02-2016

REVISION
01

Figure 1 Outline PG-SOT223, dimensions in mm/inches



700V CoolMOS™ CE Power Transistor IPN70R1K5CE

7 Appendix A

Table 11 Related Links

- IFX CoolMOS Webpage: www.infineon.com
- IFX Design tools: www.infineon.com



700V CoolMOS™ CE Power Transistor

IPN70R1K5CE

Revision History

IPN70R1K5CE

Revision: 2016-04-29, Rev. 2.0

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0 | 2016-04-29 | Release of final version |

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